

**MAXIMUM RATINGS:** ( $T_A=25^\circ\text{C}$ )

Peak Repetitive Reverse Voltage	$V_{RRM}$	150	V
Peak Working Reverse Voltage	$V_{RWM}$	125	V
Average Forward Current	$I_O$	150	mA
Forward Steady-State Current	$I_F$	225	mA
Recurrent Peak Forward Current	$i_f$	600	mA
Peak Forward Surge Current (1.0s pulse)	$I_{FSM}$	500	mA
Peak Forward Surge Current (1.0μs pulse)	$I_{FSM}$	4.0	A
Power Dissipation	$P_D$	500	mW
Operating and Storage	$T_J, T_{stg}$	-65 to +200	°C
Junction Temperature	$\Theta_{JA}$	350	°C/W
Thermal Resistance			

**ELECTRICAL CHARACTERISTICS:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
$BV_R$	$I_R=100\mu\text{A}$	150		V
$I_R$	$V_R=125\text{V}$		1.0	nA
$I_R$	$V_R=125\text{V}, T_A=125^\circ\text{C}$		500	nA
$I_R$	$V_R=125\text{V}, T_A=150^\circ\text{C}$		3.0	μA
$I_R$	$V_R=30\text{V}, T_A=125^\circ\text{C}$		300	nA
$V_F$	$I_F=1.0\text{mA}$	0.54	0.69	V
$V_F$	$I_F=5.0\text{mA}$	0.62	0.77	V
$V_F$	$I_F=10\text{mA}$	0.65	0.80	V
$V_F$	$I_F=50\text{mA}$	0.75	0.88	V
$V_F$	$I_F=100\text{mA}$	0.79	0.92	V
$V_F$	$I_F=200\text{mA}$	0.83	1.00	V
$C_T$	$V_R=0, f=1.0\text{MHz}$		8.0	pF
$t_{rr}$	$V_R=3.5\text{V}, I_f=10\text{mA}, R_L=1.0\text{k}\Omega$		3.0	μs

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**DESCRIPTION:**

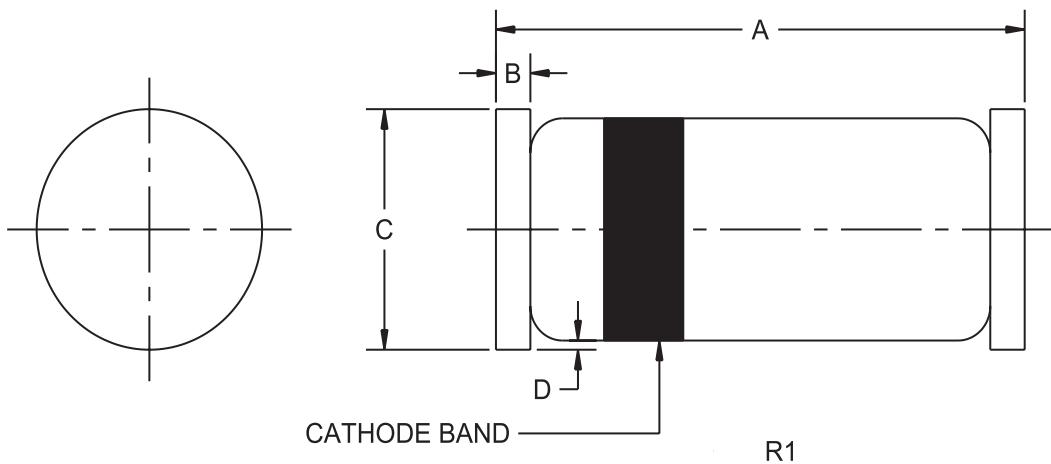
The CENTRAL SEMICONDUCTOR CLL3595 type is an epitaxial planar silicon diode, manufactured in a hermetically sealed glass surface mount package, designed for low leakage, high conductance applications.

**Central**<sup>TM</sup>  
Semiconductor Corp.

CLL3595

**SURFACE MOUNT  
LOW LEAKAGE SILICON DIODE**

**SOD-80 CASE - MECHANICAL OUTLINE**



SYMBOL	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.130	0.146	3.30	3.71
B	0.016		0.41	
C (DIA)	0.051	0.067	1.30	1.70
D	-	0.004	-	0.10

SOD-80 (REV:R1)

R1 ( 25-September 2001)